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December 12, 2003

**Mail Stop Patent Application**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Attorney Reference: COR 136

**Re:** New Patent Application of: Jui-Neng TU

**Title:** DUAL DAMASCENE PROCESS FOR FORMING A MULTI-LAYER  
LOW-K DIELECTRIC INTERCONNECT

Sir:

Please find attached hereto an application for patent which includes:

- [x] Specification, Claims and Abstract (15 pages)
- [x] 5 Sheets of Formal Drawings (Fig. 1 through Fig. 9)

In view of the above, it is requested that this application be accorded a filing date pursuant to 37 C.F.R. 1.53(b).

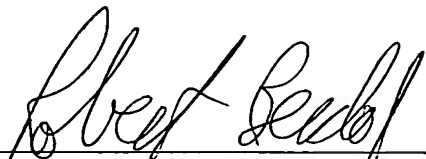
A Declaration signed by the inventor, and the filing fee will be submitted in due course.

Respectfully submitted,

December 12, 2003

Date

RHB:QZ:tz

  
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(CUSTOMER NO. 23995)